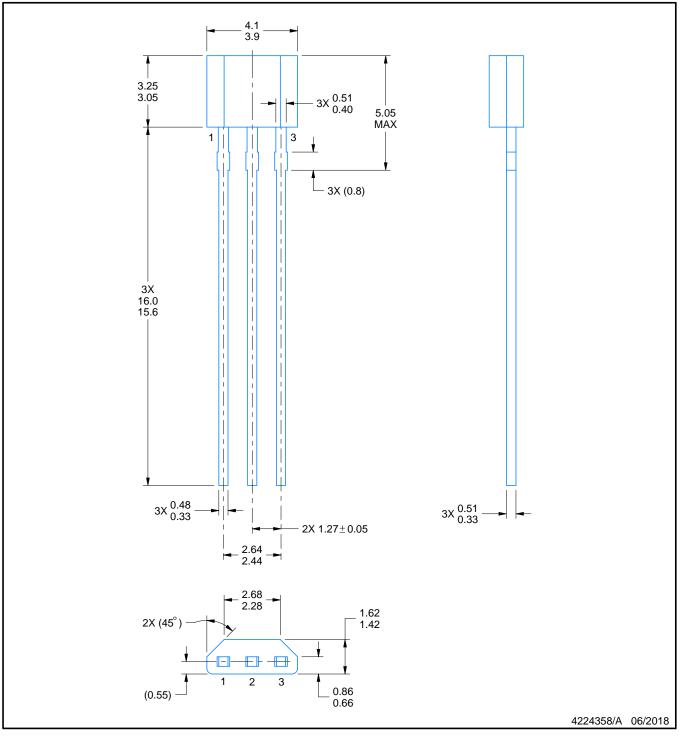
LPE0003A



PACKAGE OUTLINE

TO-92 - 5.05 mm max height

TRANSISTOR OUTLINE



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice.

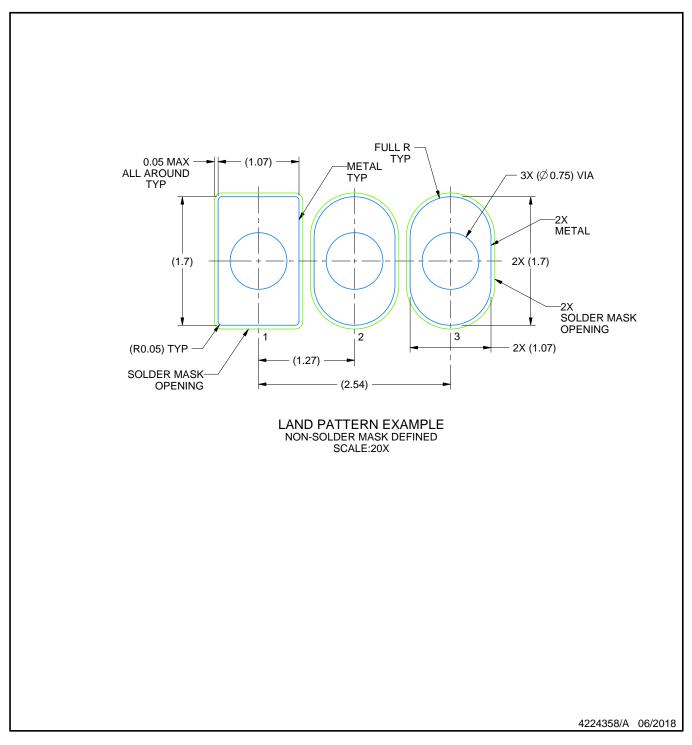


LPE0003A

EXAMPLE BOARD LAYOUT

TO-92 - 5.05 mm max height

TRANSISTOR OUTLINE



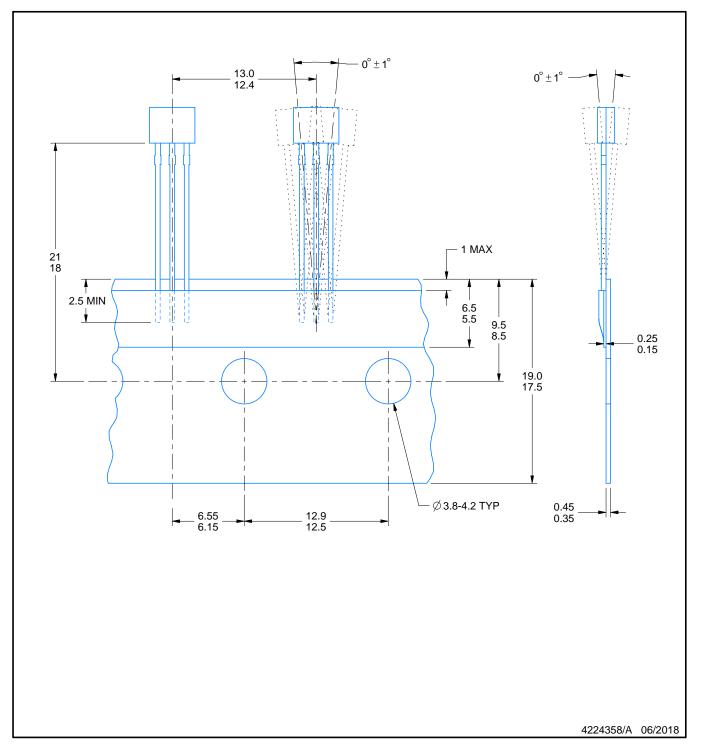


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TAPE SPECIFICATIONS

TO-92 - 5.05 mm max height

TRANSISTOR OUTLINE





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